

Soldering Temperature	T _{sol}	260	
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NOTE1 $I_{F1} \dots \cdot \% \mu i \theta ; (\text{OE} \text{ } \mu \text{ v } \zeta$

NOTE2 $() \text{OE} \text{ } i u] v \mu \checkmark U Z X , X A \delta i \cdot \delta i 9$

ELECTRICAL CHARACTERISTICS fl Temperature 1 25 š C Ł

Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit
Input	Forward Voltage	V _F	I _F 1 10mA	-	1.8	2.5	V
	Reverse Current	I _R	V _R 1 6V	-	-	1	A
	Input Capacitance	C _i	V 1 0V f 1 1M < n	-	70	-	pF
Detector	Off-state Current	I _{OFF}	V _{OFF} 1 100V	-	-	10	nA
	Output Capacitance	C _{OFF}	V 1 0V f 1 1M < n t 0 1s	-	170	-	pF
	Trigger LED Current	I _{FT}	I _{ON} 1 2A	-	0.35	1	mA
						-	mA
						1	
						-	

ORDERING INFORMATION

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Characteristics Curves

FIG.1: Max. Allowable LED Forward Current vs. Ambient Temperature

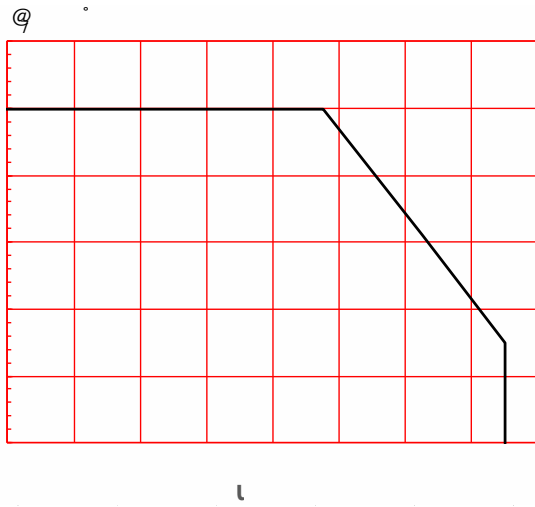


FIG.2: On-state Current vs. Ambient Temperature

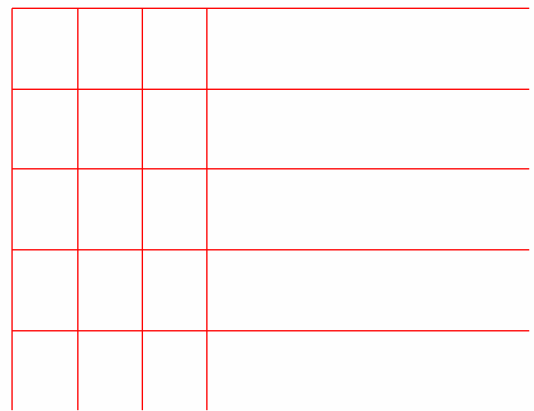
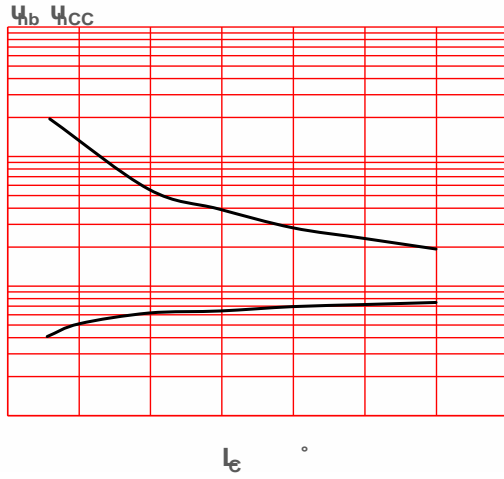
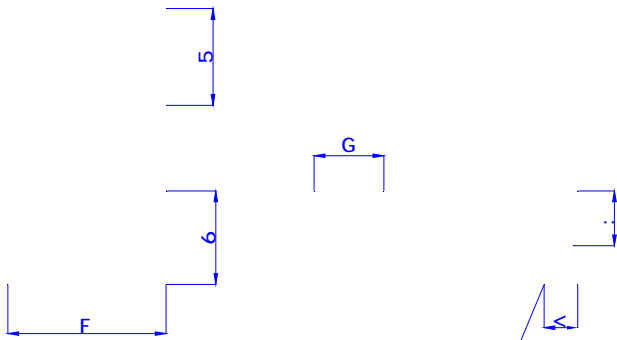


FIG.7: T_{ON},T_{OFF} vs. LED Forward Current

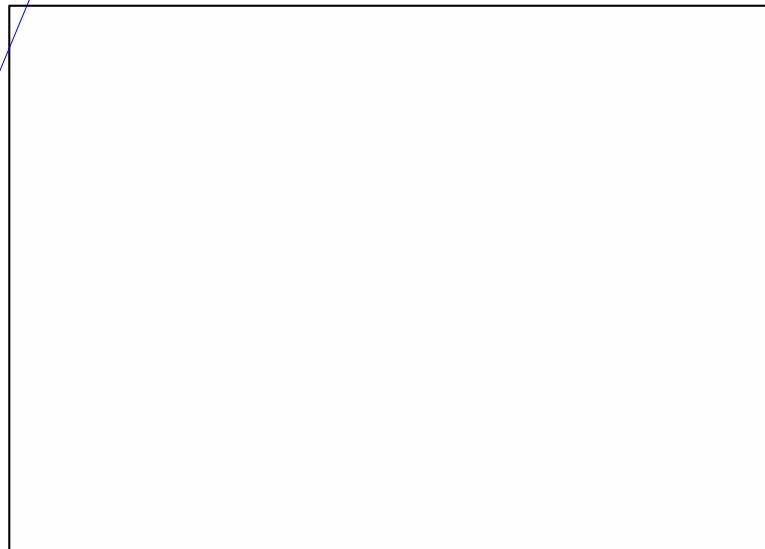
FIG.8: T_{ON},T_{OFF} vs. Ambient Temperature



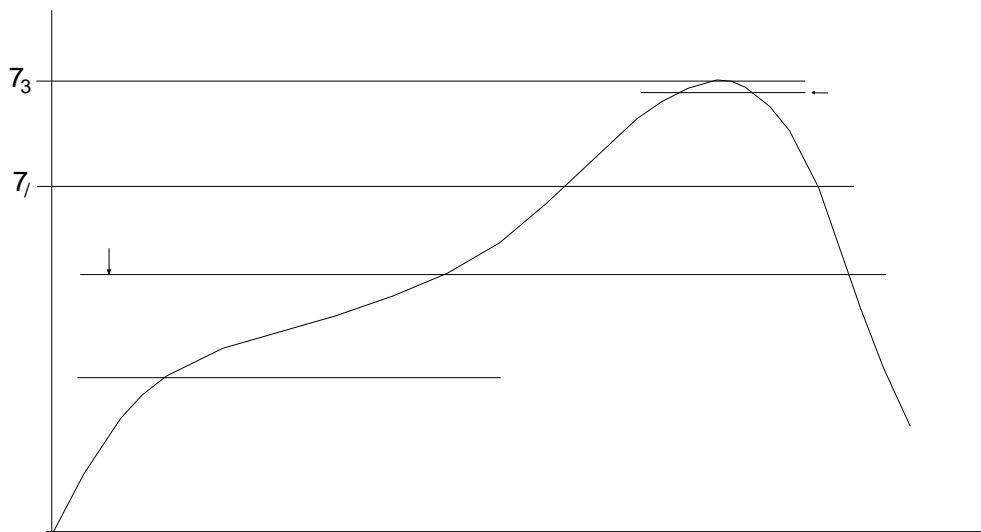
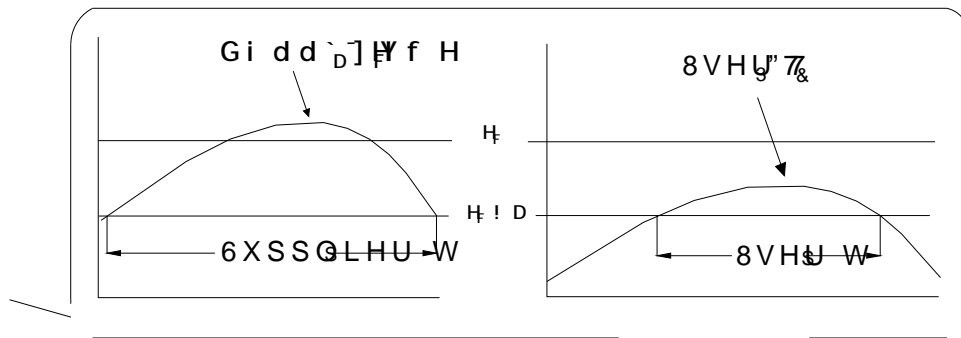
Package Dimension (Unit: mm)



F Y Z B	G] a Y b g] c b g			
	A] b B Hmd	B A Ml	B A] b B Hmd	B A Ml B
5	%B' \$	%B+ \$	\$ B\$ D%	\$ B\$ * +
6	%BE\$	& B' \$	\$ B\$ + D	\$ B\$ E%
F	' B& \$	' B* \$	\$ B%& *	\$ B%(&
G	\$ B, ,	%B&, ,	\$ B\$ ' D	\$ B\$ D\$
9	& B%D	& BDD	\$ B\$, D	\$ B%\$ \$
:	%B\$ \$	%B(\$	\$ B\$ ' E	\$ B\$ DD
;	\$ B& \$	\$ B* \$	\$ B\$ \$, ,	\$ B\$ & (
<	\$ B* D	!		



REFLOW INFORMATION



Note:

1. Reflow soldering is recommended at the temperatures and ~~is~~ shown, no more than three times.
2. Avoid direct contact between the epoxy body and any tools or surfaces exceeding its maximum storage temperature.
3. Application of pressure on the epoxy body is prohibited at elevated temperatures. In specific scenarios, any applied force must not exceed 2.5N.
4. Ensure the component has cooled to ambient temperature before proceeding with any subsequent manufacturing steps.
5. The component has a shelf life of one year when stored under standard conditions.
6. Recommend storage Temp.: 0 r 40 š C /

Recommend storage humidity: 0 60 r /

MSL level: MSL 3

Information furnished in this document is believed to be accurate and reliable. However, Jiangsu JieJie Microelectronics

document may solve do

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